

ESDA6V8UD

**4-Lines, Uni-directional, Ultra-low Capacitance
Transient Voltage Suppressors**

<http://www.sh-willsemi.com>

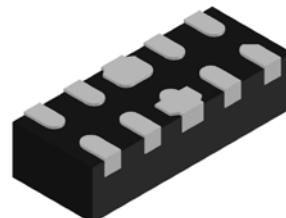
Descriptions

The ESDA6V8UD is an ultra-low capacitance TVS (Transient Voltage Suppressor) array designed to protect high speed data interfaces. It has been specifically designed to protect sensitive electronic components which are connected to data and transmission lines from over-stress caused by ESD (Electrostatic Discharge).

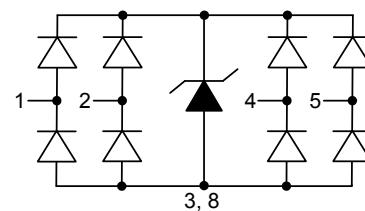
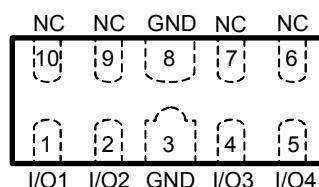
The ESDA6V8UD incorporates four pairs of ultra-low capacitance steering diodes plus a TVS diode.

The ESDA6V8UD may be used to provide ESD protection up to $\pm 20\text{kV}$ (contact discharge) according to IEC61000-4-2, and withstand peak pulse current up to 4A (8/20 μs) according to IEC61000-4-5.

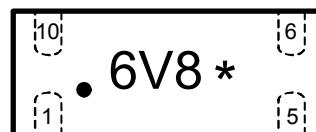
The ESDA6V8UD is available in DFN2510-10L package. Standard products are Pb-free and Halogen-free.



DFN2510-10L (Bottom view)



Pin configuration (Top view)



6V8 = Device code

* = Month code (A~Z)

Marking & Pin configuration

Order information

Device	Package	Shipping
ESDA6V8UD-10/TR	DFN2510-10L	3000/Tape&Reel

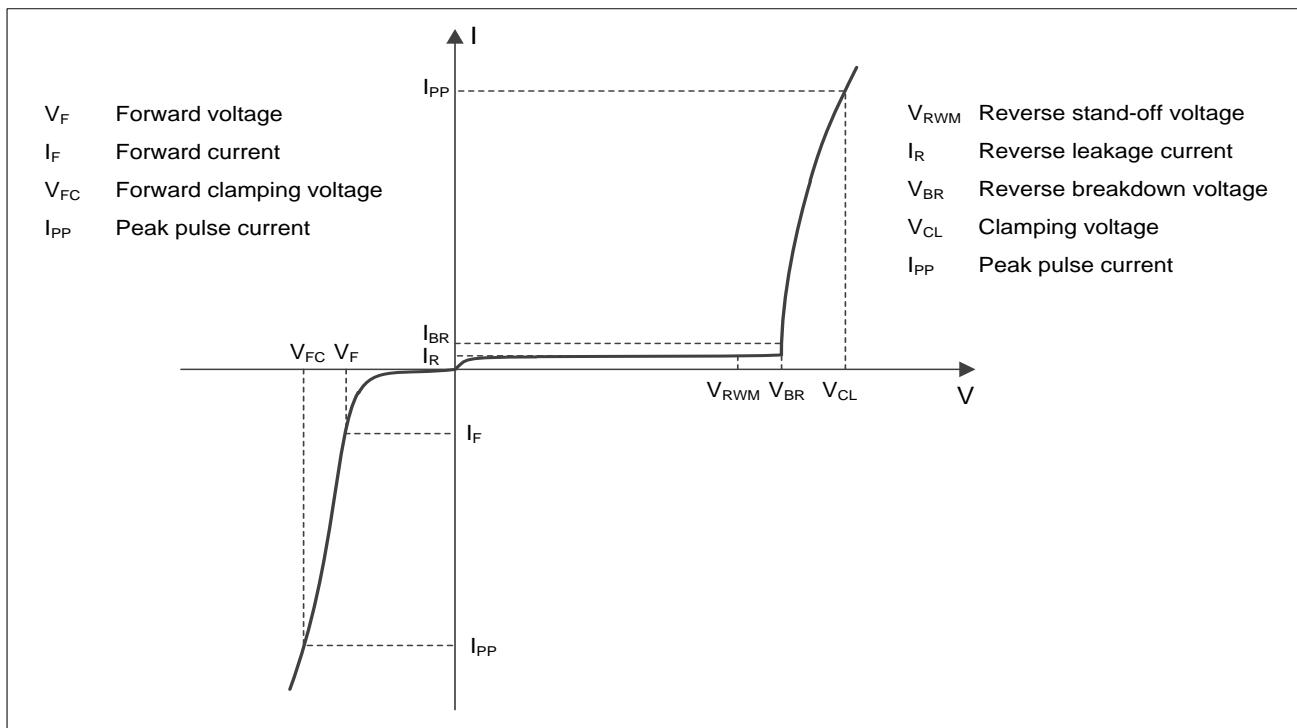
Applications

- USB 2.0 and USB 3.0
- HDMI 1.3, HDMI 1.4 and HDMI 2.0
- SATA and eSATA
- DVI
- IEEE 1394
- PCI Express
- Portable Electronics and Notebooks

Absolute maximum ratings

Parameter	Symbol	Rating	Unit
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	48	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{PP}	4	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 20	kV
ESD according to IEC61000-4-2 contact discharge		± 20	
Junction temperature	T_J	125	$^{\circ}C$
Operating temperature	T_{OP}	-40~85	$^{\circ}C$
Lead temperature	T_L	260	$^{\circ}C$
Storage temperature	T_{STG}	-55~150	$^{\circ}C$

Electrical characteristics ($T_A=25^{\circ}C$, unless otherwise noted)



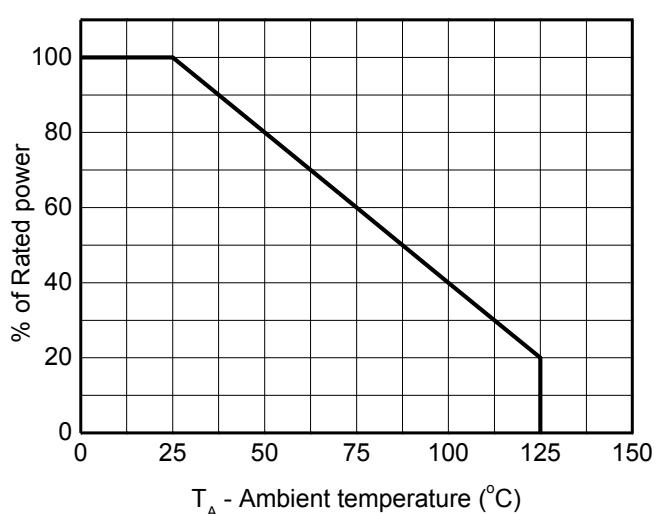
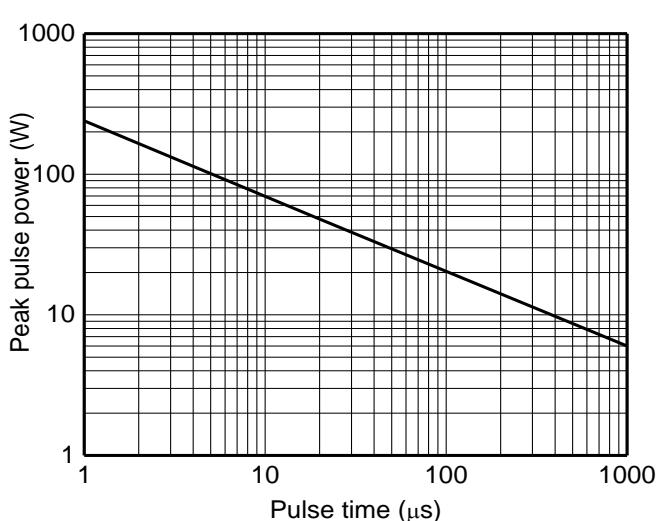
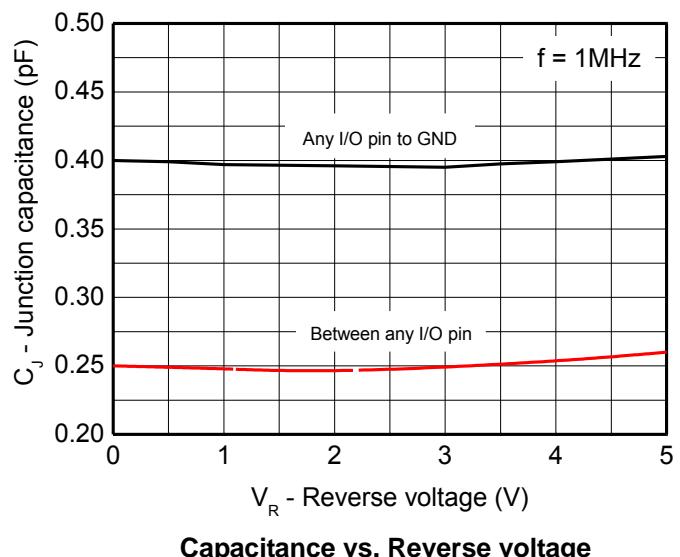
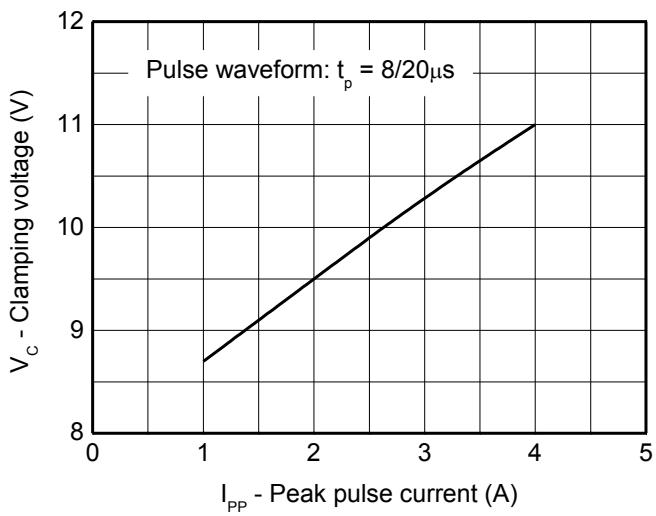
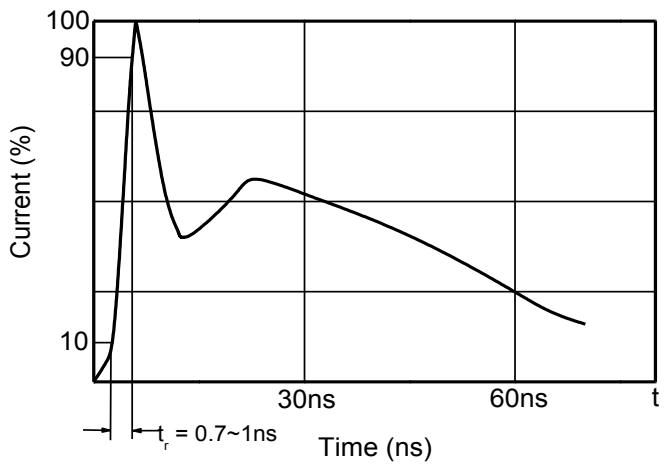
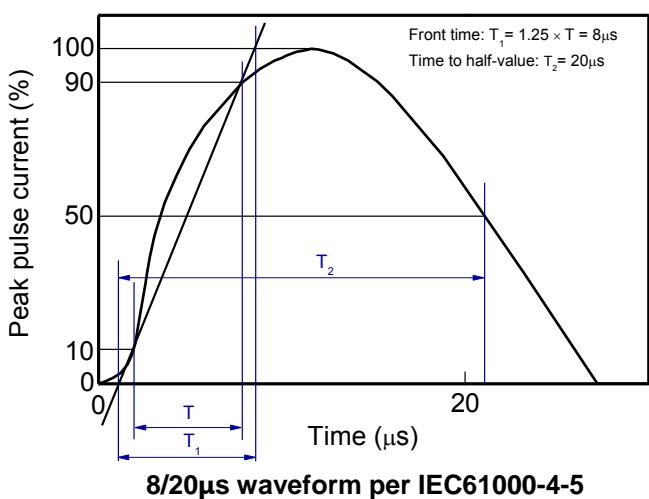
Definitions of electrical characteristics

Electrical characteristics ($T_A = 25^\circ\text{C}$, unless otherwise noted)

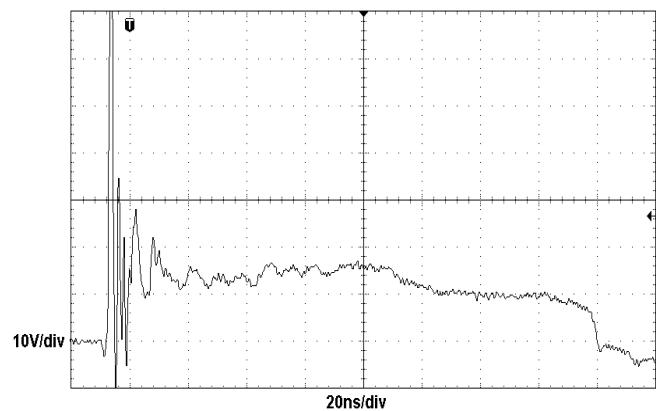
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse maximum working voltage	V_{RWM}				5.0	V
Reverse leakage current	I_R	$V_{RWM} = 5\text{V}$		<1	100	nA
Reverse breakdown voltage	V_{BR}	$I_T = 1\text{mA}$	7.0	8.0	9.0	V
Forward voltage	V_F	$I_T = 10\text{mA}$	0.6	0.9	1.2	V
Clamping voltage ¹⁾	V_{CL}	$I_{PP} = 16\text{A}, t_p = 100\text{ns}$		14		V
Dynamic resistance ¹⁾	R_{DYN}			0.35		Ω
Clamping voltage ²⁾	V_{CL}	$V_{ESD} = +8\text{kV}$		15		V
Clamping voltage ³⁾	V_{CL}	$I_{PP} = 1\text{A}, t_p = 8/20\mu\text{s}$			10	V
		$I_{PP} = 4\text{A}, t_p = 8/20\mu\text{s}$			12	V
Junction capacitance	C_J	$V_R = 0\text{V}, f = 1\text{MHz}$ Any I/O pin to GND		0.40	0.65	pF
		$V_R = 0\text{V}, f = 1\text{MHz}$ Between any I/O pin		0.25	0.40	pF

Notes:

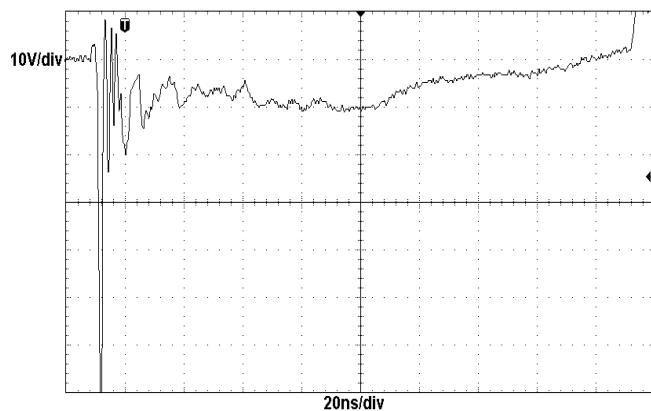
- 1) TLP parameter: $Z_0 = 50 \Omega$, $t_p = 100\text{ns}$, $t_r = 2\text{ns}$, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.
- 2) Contact discharge mode, according to IEC61000-4-2.
- 3) Non-repetitive current pulse, according to IEC61000-4-5.

Typical characteristics ($T_A = 25^\circ\text{C}$, unless otherwise noted)


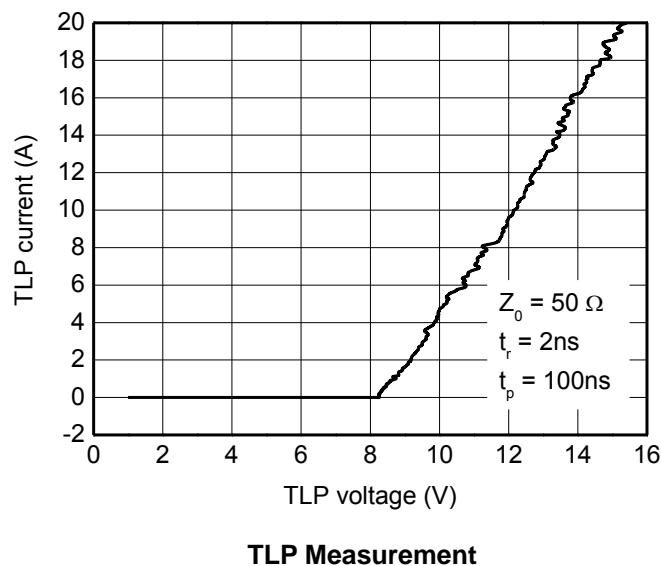
Typical characteristics ($T_A = 25^\circ\text{C}$, unless otherwise noted)



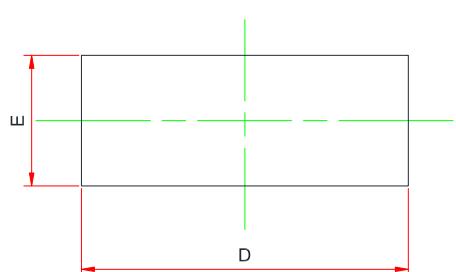
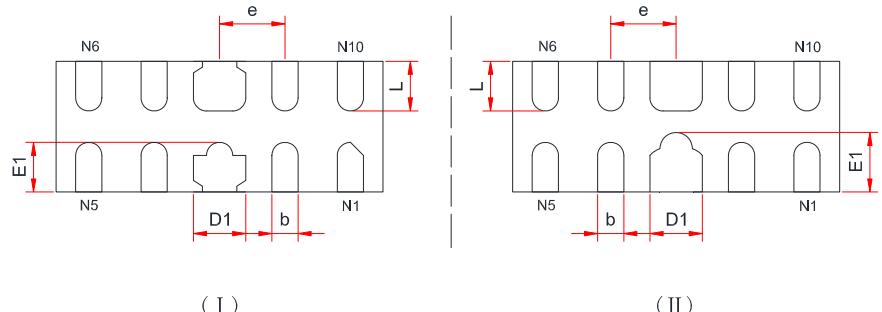
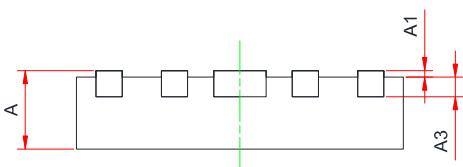
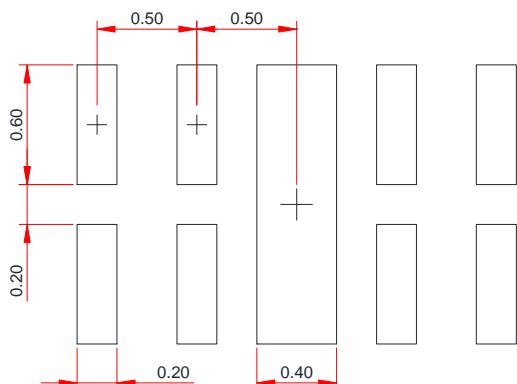
ESD clamping
(+8kV contact discharge per IEC61000-4-2)



ESD clamping
(-8kV contact discharge per IEC61000-4-2)



TLP Measurement

Package outline dimensions
DFN2510-10L

Top View

(I)
(II)
Bottom View

Side View
Recommend Land Pattern (Unit: mm)


Symbol	Dimensions in millimeter		
	Min.	Typ.	Max.
A	0.500	0.575	0.650
A1	0.000	-	0.050
A3 0.150 Ref.			
D	2.400	2.500	2.600
E	0.900	1.000	1.100
D1	0.300	0.400	0.500
E1	0.300	0.455	0.610
b	0.130	0.200	0.250
e	0.500 BSC		
L	0.300	0.400	0.500

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.